# **MA2S728**

## Silicon epitaxial planar type

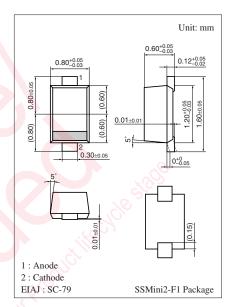
#### For switching

#### ■ Features

- High-density mounting is possible
- ullet Low forward voltage  $V_F$  and good wave detection efficiency  $\eta$
- Small temperature coefficient of forward characteristic
- Small reverse current I<sub>R</sub>

## ■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Reverse voltage	$V_R$	30	V	
Maximum peak reverse voltage	V <sub>RM</sub>	30	V	
Peak forward current	$I_{FM}$	150	mA	
Forward current	$I_{F}$	30	mA	
Junction temperature	T <sub>j</sub>	125	°C	
Storage temperature	$T_{stg}$	-55 to +125	°C	

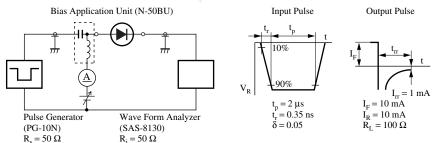


Marking Symbol: B

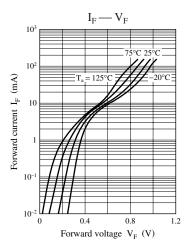
### ■ Electrical Characteristics T<sub>a</sub> = 25°C ± 3°C

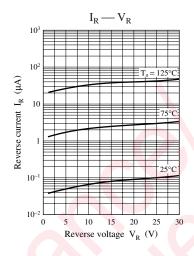
Parameter		Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage		$V_{F1}$	$I_F = 1 \text{ mA}$	16,	76,	0.4	V
		V <sub>F2</sub>	$I_F = 30 \text{ mA}$			1.0	
Reverse current		$I_R$	$V_R = 30 \text{ V}$	100	30/	300	nA
Terminal capacitance		Ct	$V_R = 1 \text{ V, f} = 1 \text{ MHz}$		1.5		pF
Reverse recovery time *	·.c	t <sub>rr</sub>	$I_F = I_R = 10 \text{ mA}$	100	1.0		ns
			$I_{rr} = 1 \text{ mA}, R_L = 100 \Omega$				
Detection efficiency	(S)	η	$V_{IN} = 3 V_{(peak)}$ , $f = 30 MHz$		65		%
			$R_L = 3.9 \text{ k}\Omega, C_L = 10 \text{ pF}$				

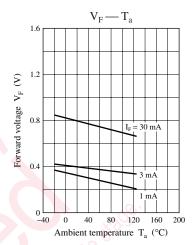
- Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.
  - 2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.
  - 3. Absolute frequency of input and output is 2 GHz.
  - 4. \*: t<sub>rr</sub> measurement circuit

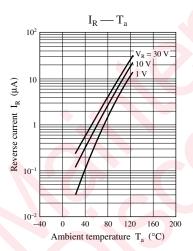


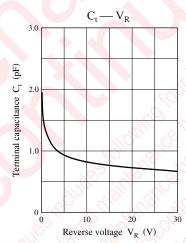
# **Panasonic**

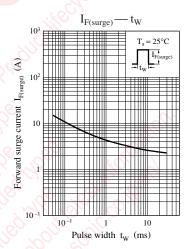












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